

APPLICATION UNDER UNITED STATES PATENT LAWS #13

Atty. Dkt. No. PW 276725
(M#)

Invention: MULTILAYER BUILD-UP WIRING BOARD

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Subst See
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Pillsbury Winthrop LLP

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1B Patent
4/27/03

This is a:

- ☐ Provisional Application
- ☐ Regular Utility Application
- ☐ Continuing Application
 - ☒ The contents of the parent are incorporated by reference
- ☐ PCT National Phase Application
- ☐ Design Application
- ☐ Reissue Application
- ☐ Plant Application
- ☐ Substitute Specification
 - Sub. Spec Filed _____
 - in App. No. _____ / _____
- ☒ Marked up Specification re

In App. No. 09/787,321

SPECIFICATION